1-3-92	2. Name a □ Yes ⊠ LG Electroni	and address of receiving cs, Inc. ng, Youngdungpo-gu	
☐ Other	Addition	nal name(s) & address(es) attached? ☐ Yes ☒ No
4. Application number(s) or patent number(s): FILED HEREWITH 10/192895 If this document is being filed together with a new application, the execution date of the application is: July 2, 2002 A. Patent Application No.(s) N/A B. Patent No.(s)			
Additional numbers attached? Yes No			
 Name and address of party to whom correspondence of document should be mailed: AMIT SHETH, Esq. LEE & HONG P.C. 221 N. FIGUEROA STREET, 11TH Floor LOS ANGELES, CALIFORNIA 90012 	7. Total fe	e (37 CFR 3.41) \$40 losed norized to be charged to account number:	o deposit account
DO NOT USE THIS SPACE			
9. Statement and signature. To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document. Amix Shell AMIT SHETH, REG. NO. 50,176 Date: July			
Mail documents to be recorded with required cover sheet information to: Assistant Commissioner for Patents Box Assignments Washington, D.C. 20231			

07/23/2002 AAHHED1 00000051 10192895 01 FC:581 40.00 DP

Attorney Docket No. 2060-3-31

ASSIGNMENT

Insert Name(s) of Inventor(s)

Hee Jun AHN

in consideration of the sum of one dollar (\$1.00) and other good and valuable considerations paid to each of the undersigned, the undersigned agree(s) to assign, and

hereby does assign, transfer and set over to

Insert name of Assignee

Insert state of Incorporation of

Assignee

Insert address of Assignee

20, Yoldo-dong, Youngdungpo-gu, Seoul, Korea

(hereinafter designated as the Assignee) the entire worldwide right, title and interest in

the invention known as

LG Electronics Inc.

Republic of Korea

Insert identification of Invention. such as Title, Case Number or Foreign Application Number

DATA COMMUNICATION METHOD

for which the undersigned has (have) executed an application for patent in the United States of America and all patent applications in foreign countries corresponding

thereto or based thereon.

Insert Date of Signing of Application

July 2, 2002

- The undersigned agree(s) to execute all papers necessary in connection with any original, reissue, divisional and continuing United States and foreign applications for the above-identified invention and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.
- The undersigned agree(s) to execute all papers necessary in connection with any interference which may be seclared concerning this application or continuation or division thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.
- The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.
- The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.
- The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to Issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed any agreement in conflict herewith. The undersigned hereby appoints JONATHAN Y. KANG, REG. NO. 38,199; RICHARD K. YOON, REG. NO. 42,247;

EDWARD GRAY, REG. NO. 35,166; DAVID N. MAKOUS, REG. NO. 29,559; JOHN S. CHRISTOPHER, REG. NO. 30,937

the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

July 2. 2002 Date:

Signature of Inventor

Hee Jun Shu

Date

Signature of Inventor

Date:

Signature of Inventor

Date:

Signature of Inventor

PATENT REEL: 013099 FRAME: 0682